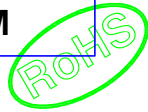
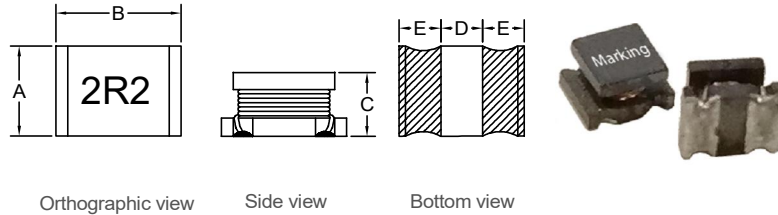


P/N: FALQH-2220-2R2M



Outline Dimensions(Unit:mm)



| A | B | C | D | E |
|-------|-------|-------|------|------|
| ±0.30 | ±0.30 | ±0.30 | REF | REF |
| 5.00 | 5.70 | 4.70 | 2.00 | 1.85 |

Recommended Soldering Temperature Graph.



Electronical Schematic



Suggested Pad layout



| | |
|---|----------|
| H | 5.50 REF |
| I | 2.85 REF |
| J | 1.80 REF |

| | Standard Profile | Standard Profile |
|------------------|---------------------|---------------------|
| Pre-heating | 150~180°C,90s±30s | |
| Heating | above 220°C,30s-60s | above 240°C,30s Max |
| Peak temperature | 245°C±3°C | 260°C,10s |
| Cycle of reflow | 2 times | 2 times |

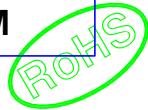
Electrical Characteristics(@25°C)

| Inductance 100KHz,0.25V | Q (Min)1.0MHz | DC Resistor | Isat (A) |
|----------------------------|------------------|-------------|-------------------|
| 2.20uH±20% | 20 | 0.041Ω Max | L(3200mA)≥90%*L0A |

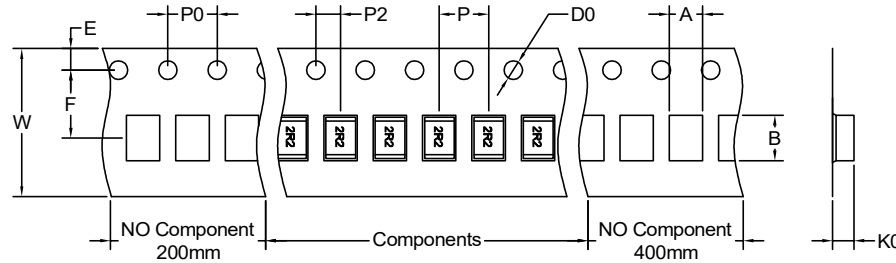
- ***Operating Temperature: -40°C~+125°C (Including temperature Rise)
- ***Storage Temperature: -40°C~+125°C
- ***Storage Humidity:RH10%~70%
- ***Temperature Rise:40°C typ.at Irms.

| | | | | | | | | |
|-----|-------------|------|------|---------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------|-----------------------|---------------------------------------------------|-----------------------------------|
| REV | DESCRIPTION | APPD | DATE | Tianchang Fuan Electronic Co Ltd www.fuantronics.net TEL: +86-550-7814888 FAX: +86-550-7831133 | Tolerances unless otherwise specified: (.X)±0.50 (.XX)±0.25 Unit of measurement: mm | Make: Qiumei.Liu | DRAWING TITLE SMD POWER WOUND INDUCTORS | Customer Name: |
| | | | | | | Checked: Beson. zhan | | Material Number: A342220XS050 |
| | | | | | | Approved: Anson. zhan | | Date of Recognition: Jan./02/2020 |

P/N: FALQH-2220-2R2M



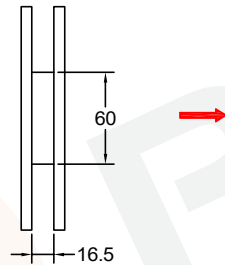
Packing Specifications(Unit:mm):



| | | | |
|----|------|----|------|
| A0 | 5.45 | F | 7.50 |
| B0 | 6.20 | D0 | 1.50 |
| P | 12.0 | K0 | 5.20 |
| P0 | 4.00 | W | 16.0 |
| P2 | 2.00 | | |
| E | 1.75 | | |



Quantity:1000pcs/Reel



Quantity: 1000pcs



PE bag



Outer cases: 8000pcs/box
Insufficient boxes filled with inner boxes or fillers



Inner box
Quantity: 4000 pcs/box

| | | | |
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| REV | DESCRIPTION | APPD | DATE |
|-----|-------------|------|------|

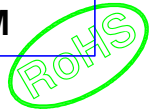
Tianchang Fuan Electronic Co Ltd
www.fuantronics.net
TEL: +86-550-7814888
FAX: +86-550-7831133

Tolerances unless otherwise specified:
(.X)±0.50 (.XX)±0.25
Unit of measurement: mm

Make: Qiumei.Liu
Checked: Beson. zhan
Approved: Anson. zhan

DRAWING TITLE
SMD POWER WOUND INDUCTORS
Material Number: A342220XS050

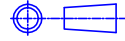
Customer Name:
Document/Rev: 00
Specification Sheet: 2 of 4
Date of Recognition: Jan./02/2020



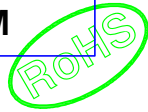
Reliability Testing:

| Ltem | Specified value | Test methods |
|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| High temperature Storage test Reference documents: MIL-STD-202G Method 108A | 1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. | Temperature:85±2°C Time:96±2 hours. Tested not less than 1 hour, not more than 2 hours at room temperature.  |
| Low temperature Storage test. Referencedocuments: IEC 68-2-1A 6.1 6.2 | 1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. | Temperature:25±2°C Time:96±2 hours. Tested not less than 1 hour, not more than 2 hours at room temperature.  |
| Humidity test Reference Documents: MIL-STD-202G Method 103B | 1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. | 1.Dry oven at a temperature of 40°±5°C for 24 hours. 2.Measurements At the end of this period 3.Exposure:Temperature:40±2°C, Humidity: 93±3%RH Time:96±2 hours. 4.Tested while the specimens are still in the chamber. 5. Tested not less than 1 hour, nor more than 2 hours at room temperature.  |
| Heat endurance of Reflow soldering | 1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. | Preheat:150°C,60 second. Solder:Sn/Ag/Cu. Solder:Temperature:260±5°C. Flux:Rosin flux. Reflow peak time 10 second at 260°C  |

| Ltem | Specified value | Test methods |
|------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Thermal shock test Reference documents: MIL-STD-202G Method 107G | 1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. For T:weiges≤28g:15 Min 28g≤weights≤136g:30 Min | First-40°C for T time,next+125°C Ttime as 1 cycle. Go through 20 cycles.  |
| Solderability test Reference documents: MIL-STD-202G Method 208H IPC J-STD-002B | Terminals area must have 95% Min. Solder coverage. | Dip pads in flux then dip in solder pot at 245±5°C for 5 second. Soler:Sn(93.5)Ag(3.5). Flux:Rosin flux. |
| Vibration test Reference documents: MIL-STD-202G Method 201A | 1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. | Apply frequency 10~55Hz. 0.75mm amplitude in each of perpendicular direction for 2 hours.(total 6 hours).  |
| Drop test Reference documents: MIL-STD-202G Method 203G | 1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%. For T:weiges≤28g:15 Min 28g≤weights≤136g:30 Min | Packaged & Drop down from 1m with 981m/s2(100G)attitude in 1 angle 1 ridges & 2 surfaces orientations. |
| Terminal strength push test Reference documents: JIS C 5321:1997 | Pulling test: DEFINE:A:sectional area of terminal A≤8(Sq M) Force≥5N time:30sec 8(Sq M)<A≤20(Sq M) Force≥10N time:10sec 20(Sq M)<A force≥20N time:10sec Bending test: Soldering the products on PCB,after the pulling testand bending test, terminal should not pull off | Bend the testing PCB at middle point, the deflection shall be 2mm  |

| | | | | | | | | |
|-----|-------------|------|------|---------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------|------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|
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|-----|-------------|------|------|---------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------|------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|

P/N: FALQH-2220-2R2M

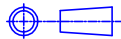


| Ltem | Specified value | Test methods |
|------------------------------------------------------------------------|-------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|
| Resistance to solvent test Reference documents: IEC 68-2-45:1993 | No case deformation or change in appearance, or obliteration of marking | To dip parts into IPA solvent for 5±0.5Min, then drying them at room temp for 5 Min, at last, to brushing making 10 times. |
| Electronic characteristic test of major products | Refer to catalogue of specific products | Refer to catalogue of specific products |
| Overload test Reference documents: | 1. During the test no smoke, no peculiar, smell, no fire | Apply twice as rated current for 5 minutes. |

Recommended solderability temperature profile:



Use rosin-based flux
Don't use high acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value).
Use lead-free solder, use Sn-3.0Ag-0.5Cu solder
Standard thickness of solder paste: 0.12-0.15mm

| | | | | Tianchang Fuan Electronic Co Ltd www.fuantronics.net TEL: +86-550-7814888 FAX: +86-550-7831133 |  Tolerances unless otherwise specified: (.X)±0.50 (.XX)±0.25 Unit of measurement: mm | Make: Qiumei.Liu Checked: Beson. zhan Approved: Anson. zhan | DRAWING TITLE SMD POWER WOUND INDUCTORS Material Number: A342220XS050 | Customer Name: Document/Rev: 00 Specification Sheet: 4 of 4 Date of Recognition: Jan./02/2020 |
|-----|-------------|------|------|---------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------|------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|
| REV | DESCRIPTION | APPD | DATE | | | | | |